

# EVLYS LTD. - POWER SEMICONDUCTORS DEVICES - Wholesale and Retail.

## Phase Control Disc Thyristor Type DT56-1250-18

High power cycling capability / Low on-state and switching losses  
Designed for traction and industrial applications

Mean on-state current		$I_{TAV}$		1250 A				
Repetitive peak off-state voltage		$V_{DRM}$		1000 ÷ 1800 V				
Repetitive peak reverse voltage		$V_{RRM}$						
Turn-off time		$t_q$		200, 250, 320, 400, 500 $\mu$ s				
$V_{DRM}, V_{RRM}, V$	1000	1100	1200	1300	1400	1500	1600	1800
Voltage code	10	11	12	13	14	15	16	18
$T_j, ^\circ C$	-60 ÷ 125							

### MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
<b>ON-STATE</b>					
$I_{TAV}$	Mean on-state current	A	1250 1394	$T_c=90^\circ C$ , Double side cooled $T_c=85^\circ C$ , Double side cooled 180° half-sine wave; 50 Hz	
$I_{TRMS}$	RMS on-state current	A	1962	$T_c=90^\circ C$ , Double side cooled 180° half-sine wave; 50 Hz	
$I_{TSM}$	Surge on-state current	kA	31.0 36.0	$T_j=T_{jmax}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=10$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
			33.0 38.0	$T_j=T_{jmax}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=8.3$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
$I^2t$	Safety factor	$A^2s \cdot 10^3$	4800 6400	$T_j=T_{jmax}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=10$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
			4500 5900	$T_j=T_{jmax}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=8.3$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
<b>BLOCKING</b>					
$V_{DRM}, V_{RRM}$	Repetitive peak off-state and Repetitive peak reverse voltages	V	1000 ÷ 1800	$T_{jmin} < T_j < T_{jmax}$ ; 180° half-sine wave; 50 Hz; Gate open	
$V_{DSM}, V_{RSM}$	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	1100 ÷ 1900	$T_{jmin} < T_j < T_{jmax}$ ; 180° half-sine wave; single pulse; Gate open	
$V_D, V_R$	Direct off-state and Direct reverse voltages	V	$0.6 \cdot V_{DRM}$ $0.6 \cdot V_{RRM}$	$T_j=T_{jmax}$ ; Gate open	

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TRIGGERING				
$I_{FGM}$	Peak forward gate current	A	8	$T_j = T_{j\max}$
$V_{RGM}$	Peak reverse gate voltage	V	5	
$P_G$	Gate power dissipation	W	4	$T_j = T_{j\max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive (f=1 Hz)	A/ $\mu$ s	2000	$T_j = T_{j\max}$ ; $V_D = 0.67 \cdot V_{DRM}$ ; $I_{TM} = 4000$ A; Gate pulse: $I_G = 2$ A; $t_{GP} = 50$ $\mu$ s; $di_G/dt \geq 2$ A/ $\mu$ s
THERMAL				
$T_{stg}$	Storage temperature	$^{\circ}$ C	-60÷50	
$T_j$	Operating junction temperature	$^{\circ}$ C	-60÷125	
MECHANICAL				
F	Mounting force	kN	24.0÷28.0	
a	Acceleration	m/s <sup>2</sup>	50	Device clamped

## CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions
ON-STATE				
$V_{TM}$	Peak on-state voltage, max	V	1.60	$T_j = 25$ $^{\circ}$ C; $I_{TM} = 3925$ A
$V_{T(TO)}$	On-state threshold voltage, max	V	0.948	$T_j = T_{j\max}$ ; $0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$
$r_T$	On-state slope resistance, max	m $\Omega$	0.189	
$I_L$	Latching current, max	mA	1500	$T_j = 25$ $^{\circ}$ C; $V_D = 12$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
$I_H$	Holding current, max	mA	300	$T_j = 25$ $^{\circ}$ C; $V_D = 12$ V; Gate open
BLOCKING				
$I_{DRM}$ , $I_{RRM}$	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	150	$T_j = T_{j\max}$ ; $V_D = V_{DRM}$ ; $V_R = V_{RRM}$
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage <sup>1)</sup> , min	V/ $\mu$ s	200, 320, 500, 1000, 1600, 2000, 2500	$T_j = T_{j\max}$ ; $V_D = 0.67 \cdot V_{DRM}$ ; Gate open
TRIGGERING				
$V_{GT}$	Gate trigger direct voltage, max	V	3.00 2.50 1.50	$T_j = T_{j\min}$ $T_j = 25$ $^{\circ}$ C $T_j = T_{j\max}$ $V_D = 12$ V; $I_D = 3$ A; Direct gate current
$I_{GT}$	Gate trigger direct current, max	mA	400 250 150	
$V_{GD}$	Gate non-trigger direct voltage, min	V	0.45	
$I_{GD}$	Gate non-trigger direct current, min	mA	50.00	$T_j = T_{j\max}$ ; $V_D = 0.67 \cdot V_{DRM}$ ; Direct gate current
SWITCHING				
$t_{gd}$	Delay time	$\mu$ s	0.75	$T_j = 25$ $^{\circ}$ C; $V_D = 1000$ V; $I_{TM} = I_{TAV}$ ; $di/dt = 200$ A/ $\mu$ s; Gate pulse: $I_G = 2$ A; $V_G = 20$ V; $t_{GP} = 50$ $\mu$ s; $di_G/dt = 2$ A/ $\mu$ s
$t_{gt}$	Turn-on time, max	$\mu$ s	4.00	
$t_q$	Turn-off time <sup>2)</sup> , max	$\mu$ s	200, 250, 320, 400, 500	$dv_D/dt = 50$ V/ $\mu$ s; $T_j = T_{j\max}$ ; $I_{TM} = I_{TAV}$ ; $di_R/dt = -10$ A/ $\mu$ s; $V_R = 100$ V; $V_D = 0.67 \cdot V_{DRM}$
$Q_{rr}$	Total recovered charge, max	$\mu$ C	2700	$T_j = T_{j\max}$ ; $I_{TM} = I_{TAV}$ ; $di_R/dt = -10$ A/ $\mu$ s; $V_R = 100$ V;
$t_{rr}$	Reverse recovery time, typ	$\mu$ s	30	
$I_{rrM}$	Peak reverse recovery current, max	A	180	

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THERMAL					
$R_{thjc}$	Thermal resistance, junction to case, max	°C/W	0.0180	Direct current	Double side cooled
$R_{thjc-A}$			0.0396		Anode side cooled
$R_{thjc-K}$			0.0324		Cathode side cooled
$R_{thck}$	Thermal resistance, case to heatsink, max	°C/W	0.0040	Direct current	
MECHANICAL					
w	Weight, max	g	510		
$D_s$	Surface creepage distance	mm (inch)	30.38 (1.196)		
$D_a$	Air strike distance	mm (inch)	18.05 (0.710)		

PART NUMBERING GUIDE							NOTES																						
DT	56	1250	18	7	3		1) Critical rate of rise of off-state voltage																						
1	2	3	4	5	6		<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="background-color: #cccccc;">Symbol of Group</th> <th style="background-color: #cccccc;">4</th> <th style="background-color: #cccccc;">5</th> <th style="background-color: #cccccc;">6</th> <th style="background-color: #cccccc;">7</th> <th style="background-color: #cccccc;">8</th> <th style="background-color: #cccccc;">8.5</th> <th style="background-color: #cccccc;">9</th> </tr> </thead> <tbody> <tr> <td><math>(dv_D/dt)_{crit}, V/\mu s</math></td> <td>200</td> <td>320</td> <td>500</td> <td>1000</td> <td>1600</td> <td>2000</td> <td>2500</td> </tr> </tbody> </table>							Symbol of Group	4	5	6	7	8	8.5	9	$(dv_D/dt)_{crit}, V/\mu s$	200	320	500	1000	1600	2000	2500
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